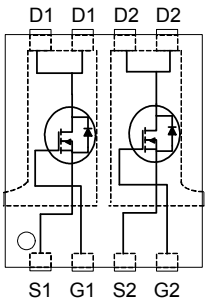
AP10A035MT

Halogen-Free Product

Advanced Power Electronics Corp.

DUAL N-CHANNEL ENHANCEMENT MODE POWER MOSFET

- ▼ **Simple Drive Requirement**
- ▼ **Fast Switching Characteristic**
- ▼ **RoHS Compliant & Halogen-Free**

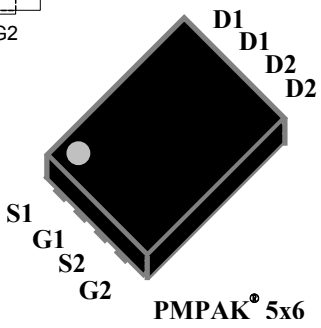


BV_{DSS}	100V
$R_{DS(ON)}$	35mΩ

Description

AP10A035 series are from Advanced Power innovated design and silicon process technology to achieve the lowest possible on-resistance and fast switching performance. It provides the designer with an extreme efficient device for use in a wide range of power applications.

PMPAK ® 5x6 dual pad provide superior thermal performance and is design for surface mount applications.



Absolute Maximum Ratings@T_j=25°C(unless otherwise specified)

Symbol	Parameter	Rating	Units
V_{DS}	Drain-Source Voltage	100	V
V_{GS}	Gate-Source Voltage	±20	V
I_D@T_C=25℃	Drain Current, V_{GS} @ 10V	17.7	A
I_D@T_A=25℃	Drain Current, V_{GS} @ 10V[3]	7.3	A
I_D@T_A=70℃	Drain Current, V_{GS} @ 10V[3]	5.8	A
I_{DM}	Pulsed Drain Current[1]	30	A
P_D@T_A=25℃	Total Power Dissipation	3.57	W
T_{STG}	Storage Temperature Range	-55 to 150	℃
T_J	Operating Junction Temperature Range	-55 to 150	℃

Thermal Data

Symbol	Parameter	Rating	Units
Rthj-c	Maximum Thermal Resistance, Junction-case	6	℃/W
Rthj-a	Maximum Thermal Resistance, Junction-ambient[3]	35	℃/W

Electrical Characteristics@T_j=25°C(unless otherwise specified)

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
BV_{DSS}	Drain-Source Breakdown Voltage	V_{GS}=0V, I_D=250uA	100	-	-	V
$R_{DS(ON)}$	Static Drain-Source On-Resistance[2]	V_{GS}=10V, I_D=7A	-	-	35	mΩ
$V_{GS(th)}$	Gate Threshold Voltage	V_{DS}=V_{GS}, I_D=250uA	2	-	4	V
g_{fs}	Forward Transconductance	V_{DS}=5V, I_D=7A	-	13	-	S
I_{DSS}	Drain-Source Leakage Current	V_{DS}=80V, V_{GS}=0V	-	-	25	uA
I_{GSS}	Gate-Source Leakage	V_{GS}=±20V, V_{DS}=0V	-	-	±0.1	uA
Q_g	Total Gate Charge	I_D=7A	-	12.5	20	nC
Q_{gs}	Gate-Source Charge	V_{DS}=50V	-	3	-	nC
Q_{gd}	Gate-Drain ("Miller") Charge	V_{GS}=10V	-	5	-	nC
$t_{d(on)}$	Turn-on Delay Time	V_{DS}=50V	-	8	-	ns
t_r	Rise Time	I_D=1A	-	7	-	ns
$t_{d(off)}$	Turn-off Delay Time	R_G=3.3Ω	-	17	-	ns
t_f	Fall Time	V_{GS}=10V	-	30	-	ns
C_{iss}	Input Capacitance	V_{GS}=0V	-	480	768	pF
C_{oss}	Output Capacitance	V_{DS}=80V	-	80	-	pF
C_{rss}	Reverse Transfer Capacitance	f=1.0MHz	-	15	-	pF
R_g	Gate Resistance	f=1.0MHz	-	0.8	1.6	Ω

Source-Drain Diode

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
V_{SD}	Forward On Voltage[2]	I_S=2.9A, V_{GS}=0V	-	-	1.2	V
t_{rr}	Reverse Recovery Time	I_S=7A, V_{GS}=0V	-	35	-	ns
Q_{rr}	Reverse Recovery Charge	dI/dt=100A/μs	-	35	-	nC

Notes:

1.Pulse width limited by Max. junction temperature.

2.Pulse test

3.Surface mounted on 1 in^2 copper pad of FR4 board, t ≤10sec ; 85 ℃/W on steady state.

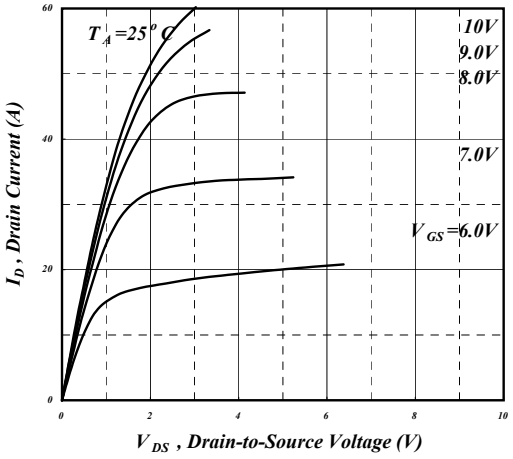


Fig 1. Typical Output Characteristics

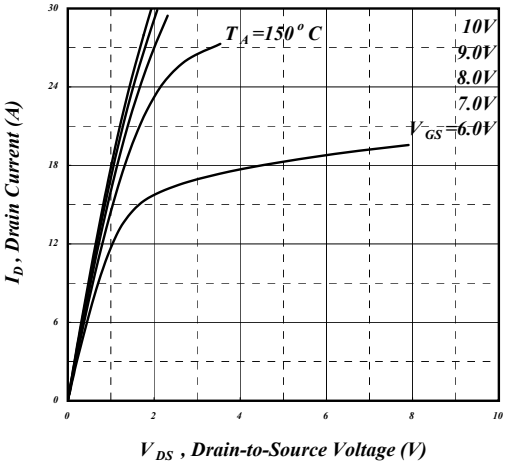


Fig 2. Typical Output Characteristics

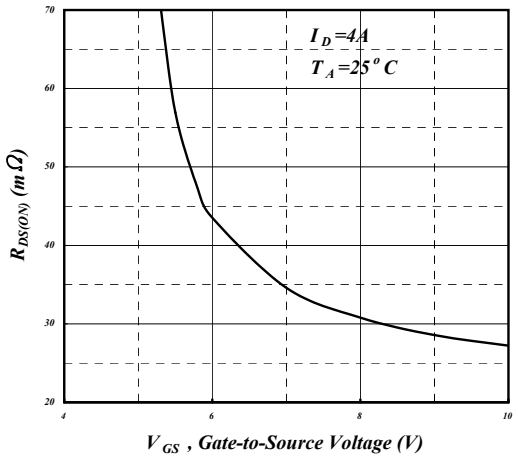


Fig 3. On-Resistance v.s. Gate Voltage

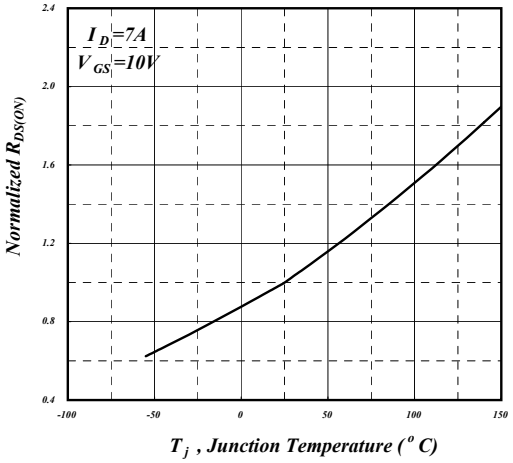


Fig 4. Normalized On-Resistance v.s. Junction Temperature

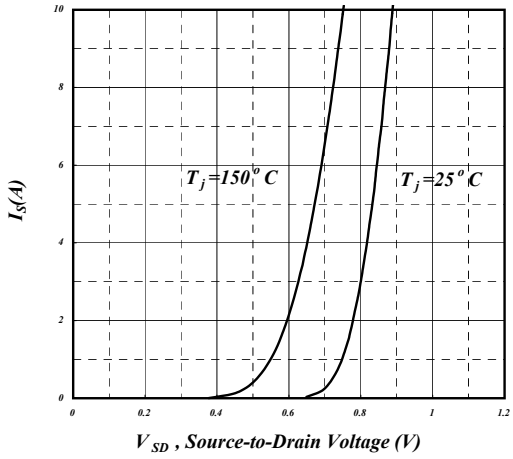


Fig 5. Forward Characteristic of Reverse Diode

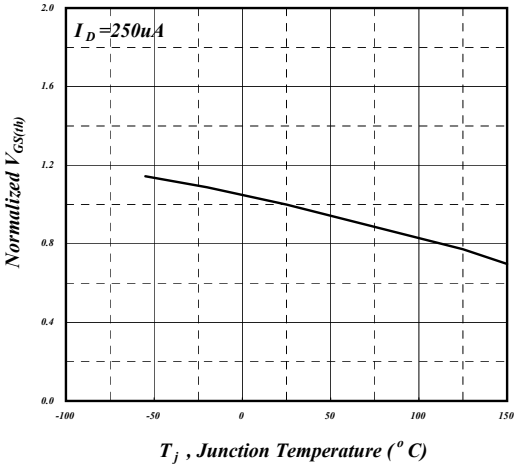


Fig 6. Gate Threshold Voltage v.s. Junction Temperature

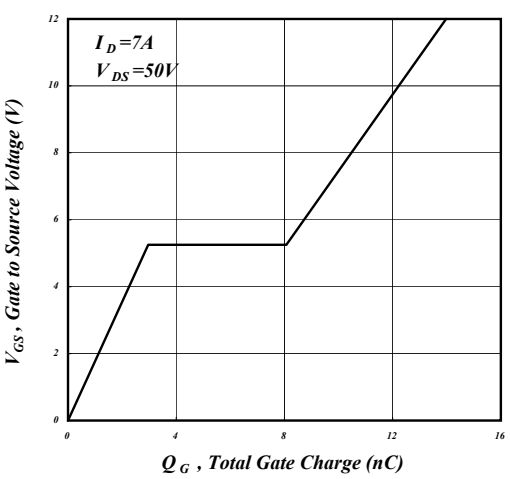


Fig 7. Gate Charge Characteristics

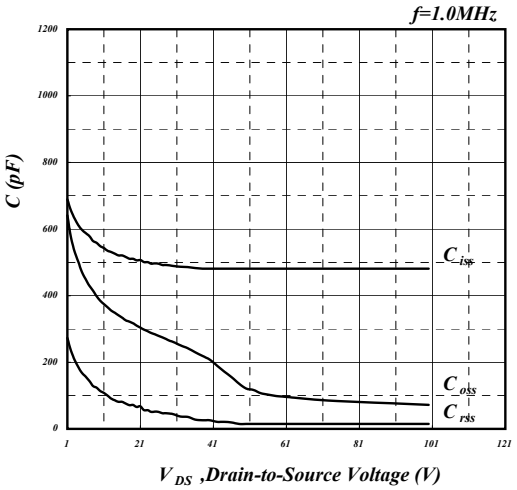


Fig 8. Typical Capacitance Characteristics

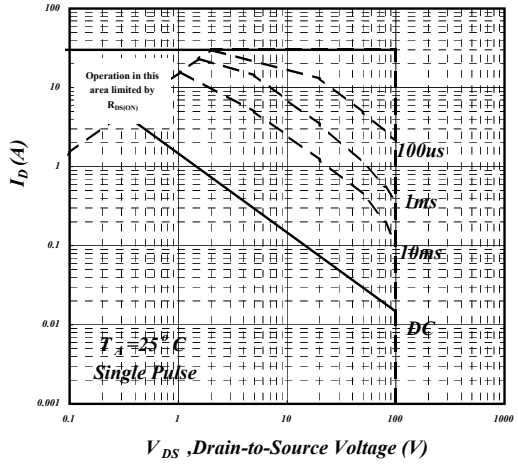


Fig 9. Maximum Safe Operating Area

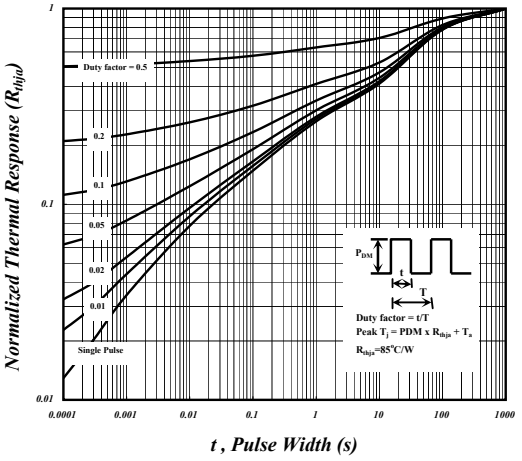


Fig 10. Effective Transient Thermal Impedance

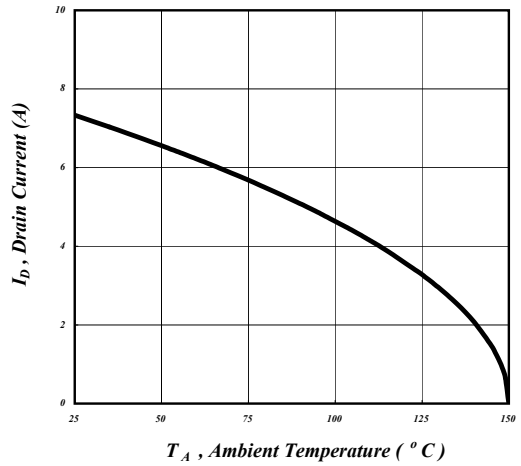


Fig 11. Drain Current v.s. Ambient Temperature

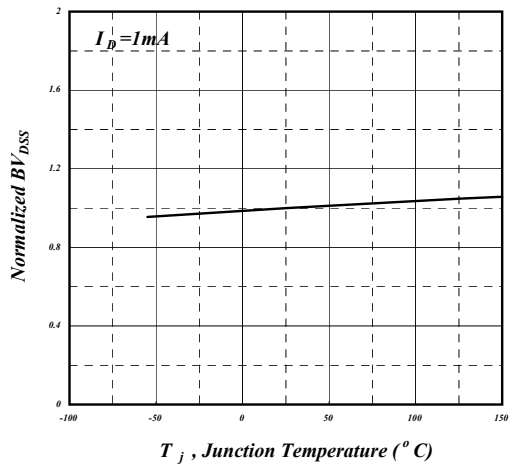
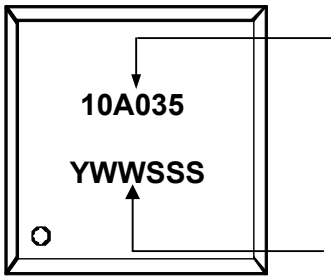


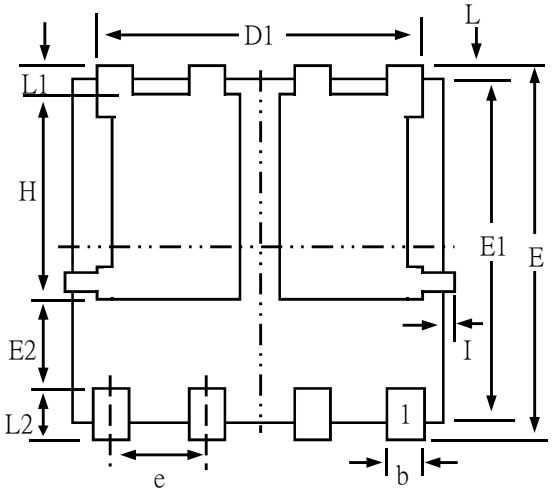
Fig 12. Normalized BV_{DSS} v.s. Junction Temperature

MARKING INFORMATION

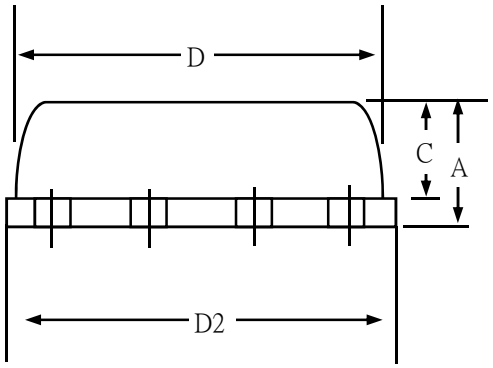


Y：Last Digit Of The Year
WW：Week
SSS：Sequence

Package Outline : PMPAK 5x6 (Dual Pad)



BACKSIDE VIEW



SYMBOLS	Millimeters		
	MIN	NOM	MAX
A	0.80	1.00	1.20
b	0.34	0.42	0.50
C	0.54	0.76	0.97
D	4.80	4.95	5.10
D1	4.11	4.21	4.31
E	5.90	6.05	6.20
E1	5.60	5.75	5.90
E2	1.60 (ref.)		
e	1.27 (ref.)		
L	0.05	0.15	0.25
L1	0.60 (ref.)		
L2	0.60 (ref.)		
H	3.60 (ref.)		
I	0.15 (ref.)		
D2	4.80	5.15	5.50

1.All Dimension Are In Millimeters.

2.Dimension Does Not Include Mold Protrusions.

Draw No. M2-1MT8-G-v02

PMPAK5X6(Dual Pad,左右) FOOTPRINT：